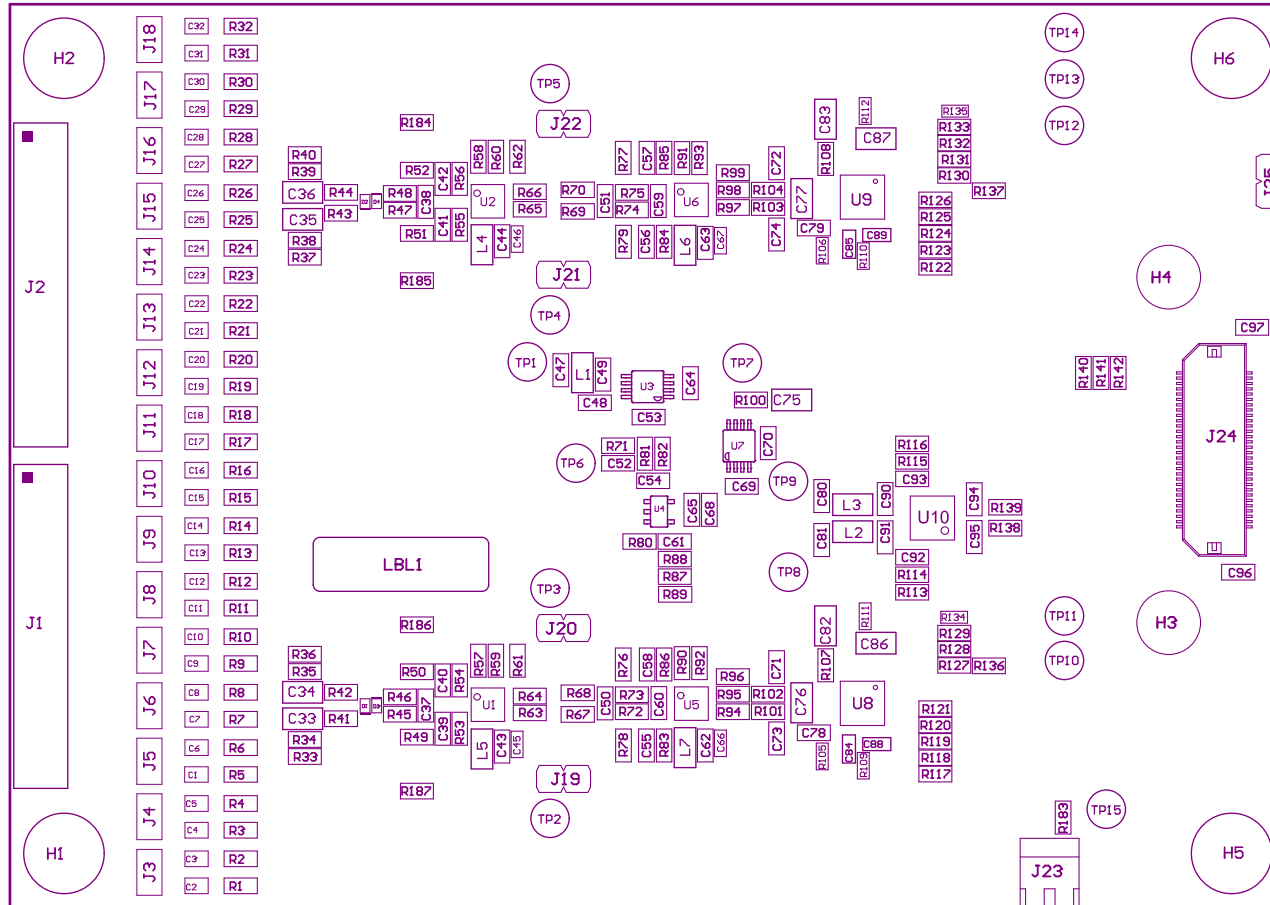
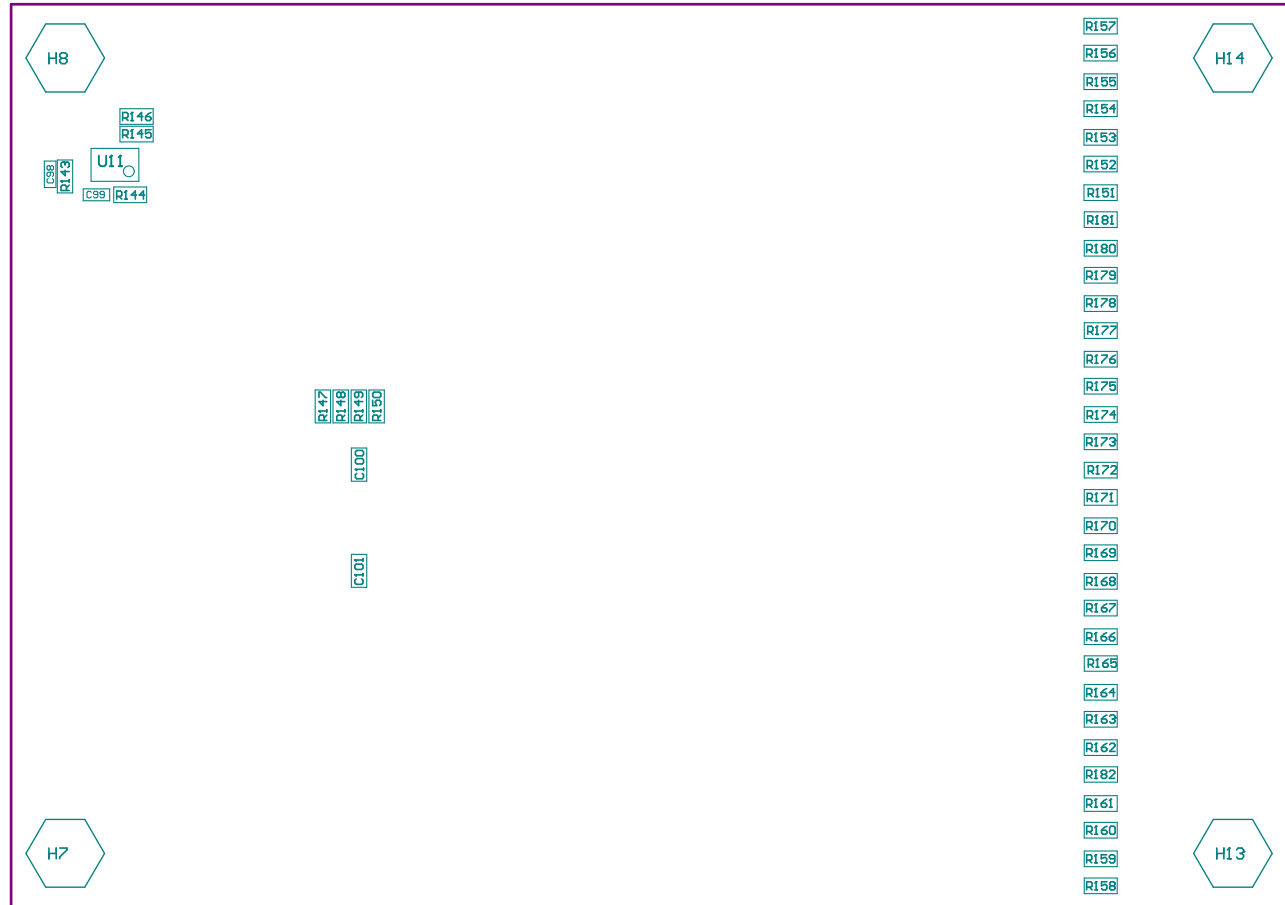


- Z24 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- Z23 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z22 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z21 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

| | | | |
|----------------------------------|-----------------------|------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE | BOARD #: TIDA-01351 | REV: E1 | SUN REV: Not In VersionControl |
| M5 Assembly Top | TID #: TIDA-01351 | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 12/7/2016 | 2:29:44 PM | TEXAS INSTRUMENTS |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

| | | | |
|-------------------------------------|-----------------------|------------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE | BOARD #: TIDA-01351 | REV: E1 | SUN REV: Not In VersionControl |
| M6 Assembly Bottom | TID #: TIDA-01351 | | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 12/7/2016 | 2:29:46 PM | TEXAS INSTRUMENTS |

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